

IN THE CLAIMS

Please cancel claims 29-30, 38-39 and 47-48 without prejudice or disclaimer of their underlying subject matter.

Please amend the claims as follows.

22. (currently amended, claim 30 placed into independent form) A thin film semiconductor device comprising:

a product substrate and a thin film device,  
wherein a manufacturing substrate is of an inorganic material,  
wherein said product substrate is one of an organic material and  
a metal,  
wherein said product substrate has a first side and a second side  
opposed to said first side,  
wherein said manufacturing substrate is adjacent said first side,  
said manufacturing substrate being closer to said first side  
than to said second side,  
wherein said thin film device is adjacent said second side, said  
thin film device being closer to said second side than to  
said first side,  
wherein said product substrate is between said thin film device  
and said manufacturing substrate,  
wherein said manufacturing substrate is removed to expose said  
first side, thereby leaving said product substrate and said  
thin film device,

wherein an adhesive layer is formed between said first surface  
and said manufacturing substrate,  
wherein said adhesive layer is dissolved to remove said  
manufacturing substrate.

23. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said manufacturing substrate is a glass substrate.

24. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said thin film device is a thin film transistor.

25. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said metal is aluminum.

26. (previously presented) A thin film semiconductor device as claimed in claim 22, wherein said organic material is a plastic.

27. (previously presented) A thin film semiconductor device as claimed in claim 26, wherein a moisture-proof buffer film is formed between said second surface and said thin film device.

28. (previously presented) A thin film semiconductor device as claimed in claim 26, wherein said plastic is from the group comprising polyether sulfone resin, polyethylene terephthalate resin and ARTON resin.

29-30. (canceled)

31. (currently amended) A thin film semiconductor device as claimed in claim ~~29~~22, wherein said adhesive layer is from the group comprising a polyimide, Teflon resin, silicon, germanium and metal.

32. (currently amended, claim 39 placed into independent form) A liquid crystal display device comprising:

a product substrate and a pixel array,  
wherein a manufacturing substrate is of an inorganic material,  
wherein said product substrate is one of an organic material and  
a metal,  
wherein said product substrate has a first side and a second side  
opposed to said first side,  
wherein said manufacturing substrate is adjacent said first side,  
said manufacturing substrate being closer to said first side  
than to said second side,  
wherein said pixel array is adjacent said second side, said pixel  
array being closer to said second side than to said first  
side,

wherein said product substrate is between said pixel array and  
said manufacturing substrate,  
wherein said manufacturing substrate is removed to expose said  
first side, thereby leaving said product substrate and said  
pixel array,  
wherein an adhesive layer is formed between said first surface  
and said manufacturing substrate,  
wherein said adhesive layer is dissolved to remove said  
manufacturing substrate.

33. (previously presented) A liquid crystal display device  
as claimed in claim 32, wherein said manufacturing substrate is a  
glass substrate.

34. (previously presented) A liquid crystal display device  
as claimed in claim 32, wherein said metal is aluminum.

35. (previously presented) A liquid crystal display device  
as claimed in claim 32, wherein said organic material is a  
plastic.

36. (previously presented) A liquid crystal display device  
as claimed in claim 35, wherein a moisture-proof buffer film is  
formed between said second surface and said pixel array.

37. (previously presented) A liquid crystal display device as claimed in claim 35, wherein said plastic is from the group comprising polyether sulfone resin, polyethylene terephthalate resin and ARTON resin.

38-39. (canceled)

40. (currently amended) A liquid crystal display device as claimed in claim ~~38~~32, wherein said adhesive layer is from the group comprising a polyimide, Teflon resin, silicon, germanium and metal.

41. (currently amended, claim 48 placed into independent form) A electroluminescence display device comprising:

a product substrate and an electroluminescence device ,  
wherein a manufacturing substrate is of an inorganic material,  
wherein said product substrate is one of an organic material and  
a metal,  
wherein said product substrate has a first side and a second side  
opposed to said first side,  
wherein said manufacturing substrate is adjacent said first side,  
said manufacturing substrate being closer to said first side  
than to said second side,  
wherein said electroluminescence device is adjacent said second  
side, said electroluminescence device being closer to said  
second side than to said first side,

wherein said product substrate is between said

electroluminescence device and said manufacturing substrate,  
wherein said manufacturing substrate is removed to expose said  
first side, thereby leaving said product substrate and said  
electroluminescence device,

wherein an adhesive layer is formed between said first surface  
and said manufacturing substrate,

wherein said adhesive layer is dissolved to remove said  
manufacturing substrate.

42. (previously presented) A electroluminescence display  
device as claimed in claim 41, wherein said manufacturing  
substrate is a glass substrate.

43. (previously presented) A electroluminescence display  
device as claimed in claim 41, wherein said metal is aluminum.

44. (previously presented) A electroluminescence display  
device as claimed in claim 41, wherein said organic material is a  
plastic.

45. (previously presented) A electroluminescence display  
device as claimed in claim 44, wherein a moisture-proof buffer  
film is formed between said second surface and said  
electroluminescence device.

46. (previously presented) A electroluminescence display device as claimed in claim 44, wherein said plastic is from the group comprising polyether sulfone resin, polyethylene terephthalate resin and ARTON resin.

47-48. (canceled)

49. (currently amended) A electroluminescence display device as claimed in claim ~~47~~41, wherein said adhesive layer is from the group comprising a polyimide, Teflon resin, silicon, germanium and metal.